Electronic Acknowledgement Receipt FES ID: 1235931 Application Number: 10599661 Confirmation Number: 2432 Palladium-plated Lead Finishing Structure For Semiconductor Part And Title of Invention: Method Of Producing Semiconductor Device First Named Inventor: Kazumitsu Seki Customer Number: 54205 Filer: Joseph A. Calvaruso/Maria Staiano Filer Authorized By: Joseph A. Calvaruso Attorney Docket Number: 17314018 Receipt Date: 04-OCT-2006 Filing Date: Time Stamp: 17:16:28 Application Type: U.S. National Stage under 35 USC 371 International Application Number: PCT/JP05/09286

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